



#### HIGH VOLTAGE SURFACE MOUNT DUAL SWITCHING DIODE

#### **Features**

- Fast Switching Speed: Maximum of 50ns
- High Reverse Breakdown Voltage: 300V
- Low Leakage Current: Maximum of 100nA when  $V_R = 240V$  at Room Temperature
- Surface Mount Package Ideally Suited for Automated Insertion
- Dual Series Configuration
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The MMBD2004SQ is suitable for automotive applications requiring specific change control and is AEC-Q101 qualified, is PPAP capable, and is manufactured in IATF16949:2016 certified facilities.

### **Mechanical Data**

- Case: SOT23
- Case Material: Molded Plastic, "Green" Molding Compound.
   UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Solderable per MIL-STD-202, Method 208
- Lead-Free Plating (Matte Tin Finish Annealed over Alloy 42 Leadframe) (a3)
- Polarity: See Diagram
- Weight: 0.008 grams (Approximate)





Top View



Internal Schematic

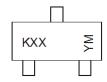
### **Ordering Information** (Note 4)

Part Number	Qualification	Case	Packaging
MMBD2004SQ-7-F	Automotive	SOT23	3000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

## **Marking Information**



KXX = Product Type Marking Code (KA9 or KAE)

YM = Date Code Marking Y = Year (ex: G = 2019) M = Month (ex: 9 = September)

Date Code Key

Date Code Ney												
Year	2001	2002	2003		2019	2020	2021	2022	2023	2024	2025	2026
Code	М	N	Р		G	Н	-	J	K	L	М	N
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec



## **Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Repetitive Peak Reverse Voltage	$V_{RRM}$	300	V
Working Peak Reverse Voltage DC Blocking Voltage	$V_{RWM}$ $V_{R}$	240	V
RMS Reverse Voltage	V <sub>R</sub> (RMS)	170	V
Forward Continuous Current (Note 5)	I <sub>FM</sub>	225	mA
Peak Repetitive Forward Current (Note 5)	I <sub>FRM</sub>	625	mA
Non-Repetitive Peak Forward Surge Current @ t = 1.0µs @ t = 1.0ps	I <sub>FSM</sub>	4.0 1.0	A

# **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	$P_{D}$	350	mW
Thermal Resistance Junction to Ambient Air (Note 5)	$R_{ hetaJA}$	357	°C/W
Operating and Storage Temperature Range	$T_{J}, T_{STG}$	-65 to +150	°C

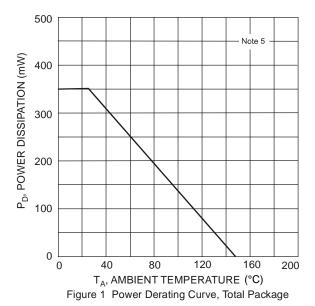
# Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

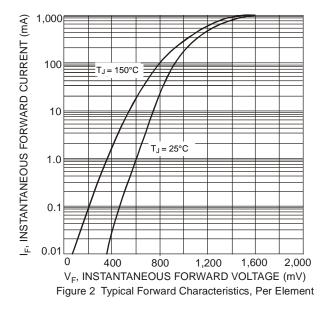
Characteristic	Symbol	Min	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 6)	$V_{(BR)R}$	300	_	V	$I_R = 100\mu A$
Forward Voltage	V <sub>F</sub>	_	0.87 1.0	V	$I_F = 20\text{mA}$ $I_F = 100\text{mA}$
Reverse Current (Note 6)	I <sub>R</sub>	_	100		V <sub>R</sub> = 240V V <sub>R</sub> = 240V, T <sub>J</sub> = +150°C
Total Capacitance	CT	_	5.0	pF	$V_R = 0$ , $f = 1.0MHz$
Reverse Recovery Time	t <sub>RR</sub>	_	50	ns	$I_F = I_R = 30 \text{mA},$ $I_{RR} = 3.0 \text{mA}, R_L = 100 \Omega$

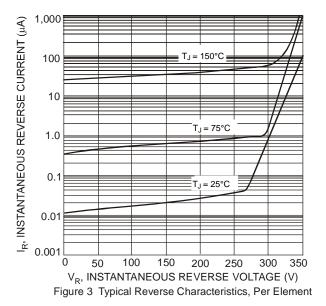
Notes:

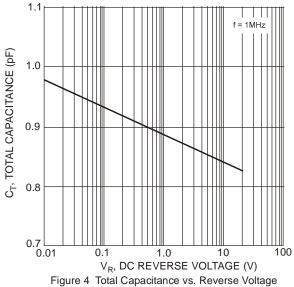
- 5. Part mounted on FR-4 substrate with pad dimensions 1 inch  $\times$  1 inch, 2oz copper, single-sided PC board. 6. Short duration pulse test used to minimize self-heating effect.











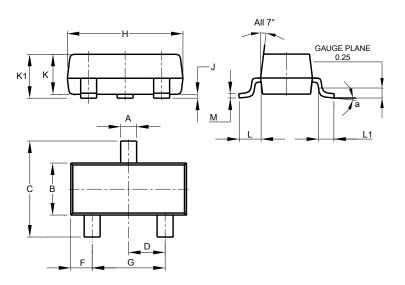
Per Element



## **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### SOT23

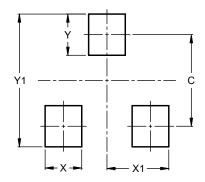


SOT23						
Dim	Min	Max	Тур			
Α	0.37	0.51	0.40			
В	1.20	1.40	1.30			
U	2.30	2.50	2.40			
D	0.89	1.03	0.915			
F	0.45	0.60	0.535			
G	1.78	2.05	1.83			
Η	2.80	3.00	2.90			
7	0.013	0.10	0.05			
K	0.890	1.00	0.975			
K1	0.903	1.10	1.025			
L	0.45	0.61	0.55			
L1	0.25	0.55	0.40			
М	0.085	0.150	0.110			
а	0°	8°				
All Dimensions in mm						

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### SOT23



Dimensions	Value (in mm)
С	2.0
X	0.8
X1	1.35
Y	0.9
Y1	2.9



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